



SCREEN CLEANER

SYS-CLEAN SCC2.0 cleaning medium is developed for cleaning SMT stencils and screens with water-soluble emulsions. **SYS-CLEAN SCC2.0** is based on non-halogenated hydrocarbon solvents and cleans reliably solder paste, SMT adhesives, thick film pastes and conductive adhesives from stencils and screens in explosion-proof equipment.

Due to the high flash point, the usage in screen printers and machines is also possible.

Application

Pollution	Suitability
Solder pastes	✓✓
SMT adhesives and conductive adhesives	✓✓
Thick film pastes	✓✓
Misprints	✓

Application Parameters

Parameter	
Application temperature	20°C
Cleaning duration approx	5-12min.
Rinsing	SCC2.0
Drying	Compressed Air
Application concentration	Ready to use

Specifications

SYS-CLEAN SCC2.0 is supplied as ready to use mixture.

Density	0,793g/cm ³
Vapor pressure at 20°C	not determined
Autoflammability	>230°C
Flashpoint	43°C
pH value	not determined



SYS-CLEAN SCC2.0

Advantages: **SYS-CLEAN SCC2.0** is due to its high flashpoint easily used without external explosion protection in explosion-protected spray cleaning systems. Also SCC2.0 can be used very well for the cleaning of misprinted circuit boards.

An additional filtering extends the very good bath life time.

SYS-CLEAN SCC2.0 can be dried very well and optimized to help shorten the cleaning time duration of the process.

Safety: Please note the information in the MSDS.

Disposal: If required, we will take back used medium and undertake the disposal for you.

Availability: **SYS-CLEAN SCC2.0** is available in pack sizes of 25 or 200 liters.



The product is free of questionable ingredients in accordance with the SIN & SVHC lists



100% compliant with the EU RoHS directive 1 & 2, WEEE